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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



32-Channel Serial to Parallel Converter With Open Drain Outputs

Features

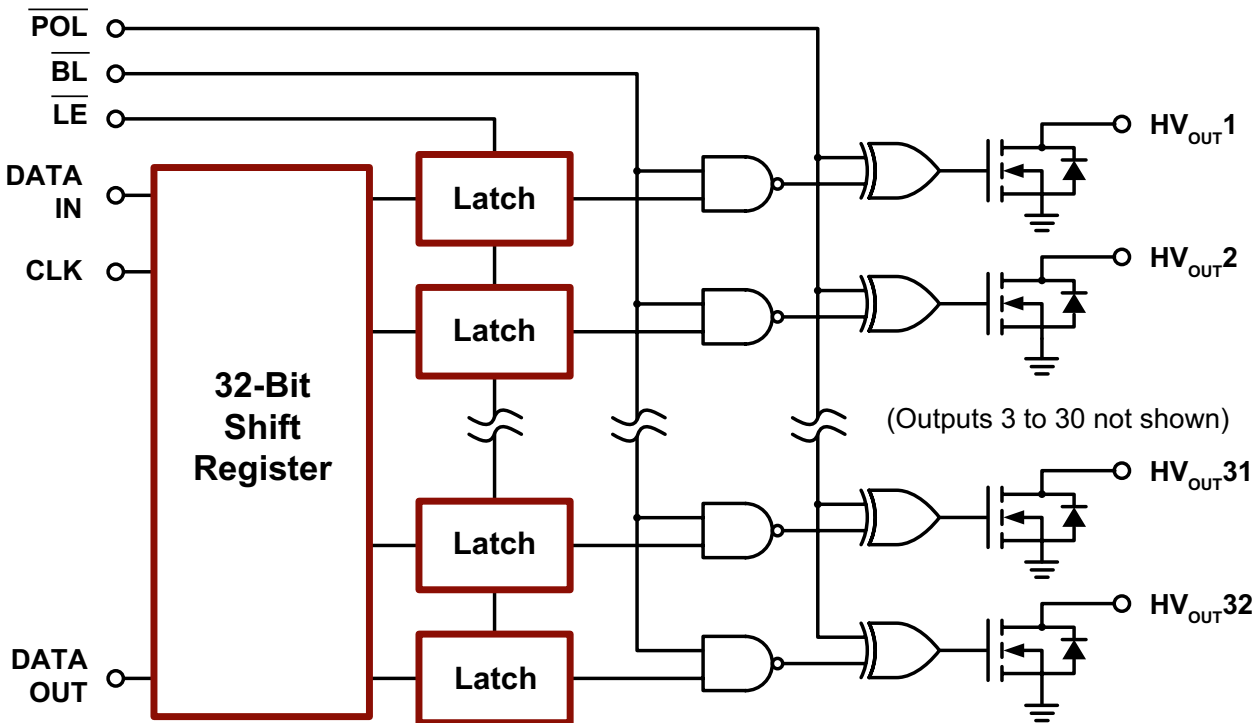
- ▶ Processed with HVCMOS® technology
- ▶ Sink current minimum 100mA
- ▶ Shift register speed 8.0MHz
- ▶ Polarity and Blanking inputs
- ▶ CMOS compatible inputs
- ▶ Forward and reverse shifting options
- ▶ Diode to VPP allows efficient power recovery

General Description

The HV5630 is a low-voltage serial to high-voltage parallel converter with open drain outputs. This device has been designed for use as a driver for AC-electroluminescent displays. It can also be used in any application requiring multiple output high voltage current sinking capabilities such as driving inkjet and electrostatic print heads, plasma panels, vacuum fluorescent, or large matrix LCD displays.

This device consists of a 32-bit shift register, 32 latches, and control logic to perform the polarity select and blanking of the outputs. Data is shifted through the shift register on the high to low transition of the clock. The HV5630 shifts in the clockwise direction when viewed from the top of the package. A data output buffer is provided for cascading devices. This output reflects the current status of the last bit of the shift register. Operation of the shift register is not affected by the \overline{LE} (latch enable), \overline{BL} (blanking), or the \overline{POL} (polarity) inputs. Transfer of data from the shift register to the latch occurs when the \overline{LE} (latch enable) input is high. The data in the latch is stored when \overline{LE} is low.

Functional Block Diagram



Ordering Information

Part Number	Package	Packing
HV5630PJ-G	44-Lead PLCC	27/Tube
HV5630PJ-G M903	44-Lead PLCC	500/Reel

-G denotes a lead (Pb)-free / RoHS compliant package

Absolute Maximum Ratings

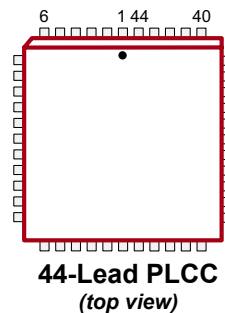
Parameter	Value
Supply voltage, V_{DD}^1	-0.5V to +15V
Output voltage, V_{PP}^1	-0.5V to +315V
Logic input levels ¹	-0.5V to $V_{DD} + 0.5V$
Ground current ²	1.5A
Continuous total power dissipation ³	1200mW
Operating temperature range	-40°C to +85°C
Storage temperature range	-65°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

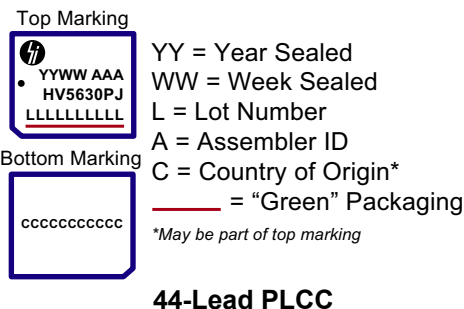
Notes:

1. All voltages are referenced to V_{SS}
2. Duty cycle is limited by the total power dissipated in the package
3. For operation above 25°C ambient derate linearly to maximum operating temperature at 20mW/°C.

Pin Configuration



Product Marking



Package may or may not include the following marks: Si or

Typical Thermal Resistance

Package	θ_{ja}
44-Lead PLCC	37°C/W

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units	Conditions
V_{DD}	Logic voltage supply	10.8	13.2	V	---
HV_{OUT}	High voltage output	-0.3	+300	V	---
V_{IH}	Input high voltage	$V_{DD} - 2.0$	V_{DD}	V	---
V_{IL}	Input low voltage	0	2.0	V	---
f_{CLK}	Clock frequency	-	8.0	MHz	---
T_A	Operating free-air temperature	-40	+85	°C	---

Power-Up Sequence

Power-up sequence should be the following:

1. Connect ground
2. Apply V_{DD}
3. Set all inputs to a known state

Power-down sequence should be the reverse of the above.

Electrical Characteristics (over recommended operating conditions unless otherwise noted)

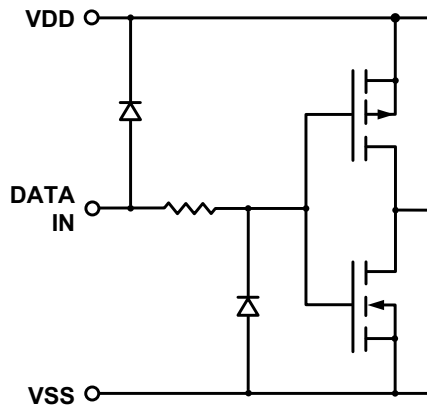
DC Characteristics

Sym	Parameter	Min	Max	Units	Conditions	
I_{DD}	V_{DD} supply current	-	15	mA	$f_{CLK} = 8.0\text{MHz}$, $F_{DATA} = 4.0\text{MHz}$	
I_{DDQ}	V_{DD} supply current (quiescent)	-	100	μA	$V_{IN} = 0\text{V}$	
$I_{O(OFF)}$	Off state output current	-	10	μA	All outputs high, all SWS parallel	
I_{IH}	High-level logic input current	-	1.0	μA	$V_{IH} = V_{DD}$	
I_{IL}	Low-level logic input current	-	-1.0	μA	$V_{IL} = 0\text{V}$	
V_{OH}	High-level output data out	$V_{DD} - 1.0\text{V}$	-	V	$I_{DOUT} = -100\mu\text{A}$	
V_{OL}	Low-level output voltage	HV _{OUT}	-	15	V	$I_{HVOUT} = +100\text{mA}$
		DATA OUT	-	1.0	V	$I_{DOUT} = +100\mu\text{A}$
V_{OC}	HV _{OUT} clamp voltage	-	-1.5	V	$I_{OL} = -100\text{mA}$	

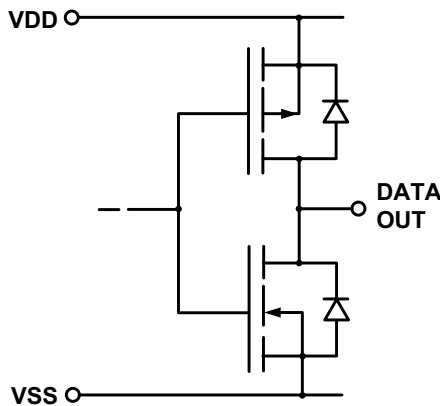
AC Characteristics ($V_{DD} = 12\text{V}$, $T_c = 25^\circ\text{C}$)

Sym	Parameter	Min	Max	Units	Conditions
f_{CLK}	Clock frequency	-	8.0	MHz	---
t_W	Clock width, high or low	62	-	ns	---
t_{SU}	Data set-up time before CLK falls	25	-	ns	---
t_H	Data hold time after CLK falls	10	-	ns	---
t_{ON}	Turn-on time, HV _{OUT} from enable	-	500	ns	$R_L = 2.0\text{K}\Omega$ to V_{PP} max.
t_{DHL}	Delay time clock to data high to low	-	100	ns	$C_L = 15\text{pF}$
t_{DLH}	Delay time clock to data low to high	-	100	ns	$C_L = 15\text{pF}$
t_{DLE}	Delay time clock to \overline{LE} low to high	50	-	ns	---
t_{WLE}	Width of \overline{LE} pulse	50	-	ns	---
t_{SLE}	\overline{LE} setup time before clock falls	50	-	ns	---

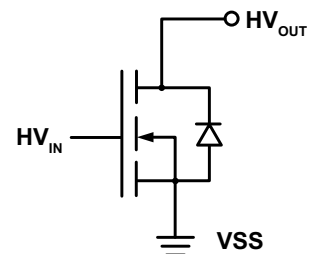
Input and Output Equivalent Circuits



Logic Inputs

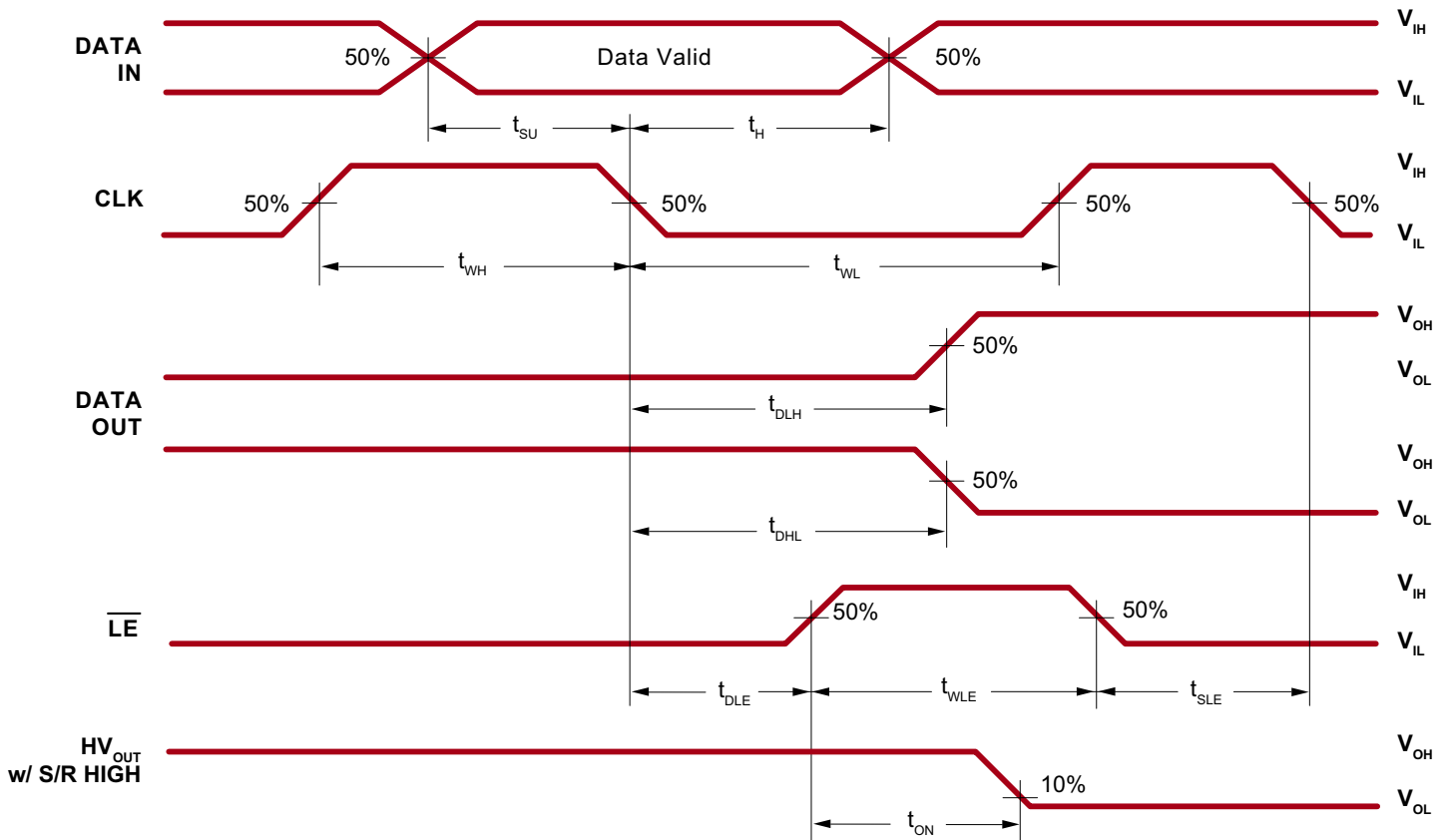


Logic Data Output



High Voltage Outputs

Switching Waveforms



Functional Table

Function	Inputs					Outputs				
	Data	CLK	\overline{LE}	\overline{BL}	\overline{POL}	Shift Reg		HV Outputs		Data Out
						1	2...32	1	2...32	*
All on	X	X	X	L	L	*	*...*	On	On...On	*
All off	X	X	X	L	H	*	*...*	Off	Off...Off	*
Invert mode	X	X	L	H	L	*	*...*	$\overline{*}$	$\overline{*...*}$	*
Load S/R	H or L	↓	L	H	H	H or L	*...*	*	*...*	*
Load latches	X	H or L	↑	H	H	*	*...*	*	*...*	*
	X	H or L	↑	H	L	*	*...*	$\overline{*}$	$\overline{*...*}$	*
Transparent latch mode	L	↓	H	H	H	L	*...*	Off	*...*	*
	H	↓	H	H	H	H	*...*	On	*...*	*

Notes:

H = high level, L = low level, X = irrelevant, ↓ = high-to-low transition, ↑ = low-to-high transition.

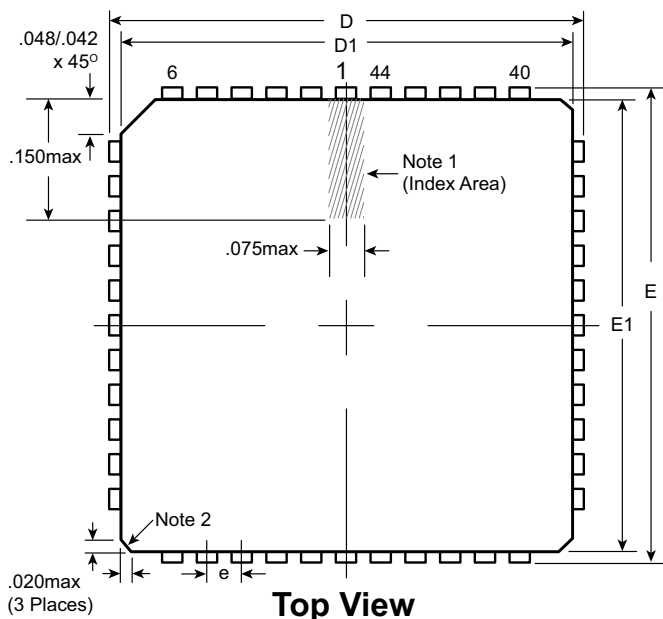
* dependent on previous stage's state before the last CLK ↓ or last \overline{LE} high.

44-Lead PLCC Pin Description

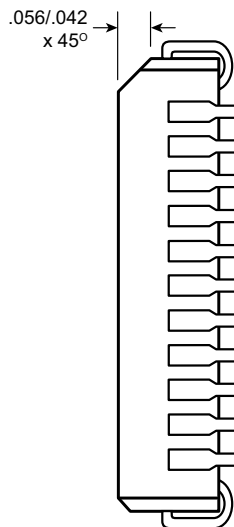
Pin	Function	Description
1	HV _{OUT} 17	High voltage outputs.
2	HV _{OUT} 16	
3	HV _{OUT} 15	
4	HV _{OUT} 14	
5	HV _{OUT} 13	
6	HV _{OUT} 12	
7	HV _{OUT} 11	
8	HV _{OUT} 10	
9	HV _{OUT} 9	
10	HV _{OUT} 8	
11	HV _{OUT} 7	
12	HV _{OUT} 6	
13	HV _{OUT} 5	
14	HV _{OUT} 4	
15	HV _{OUT} 3	
16	HV _{OUT} 2	
17	HV _{OUT} 1	
18	DATA OUT	Data output pin.
19	N/C	No internal connection.
20	N/C	
21	N/C	
22	$\overline{\text{POL}}$	Inverts the polarity of the HV _{OUT} pins
23	CLK	Clock pin, shift registers shift data on falling edge of input clock.
24	VSS	Reference voltage, usually ground.
25	VDD	Logic supply voltage.
26	$\overline{\text{LE}}$	Latch enable pin, data is shifted from shift register to latches on logic input high.
27	DATA IN	Data input pin.
28	$\overline{\text{BL}}$	Blanking pin sets all HV _{OUT} pins low or high depending upon state of polarity. See function table.
29	N/C	No internal connection.
30	HV _{OUT} 32	High voltage outputs.
31	HV _{OUT} 31	
32	HV _{OUT} 30	
33	HV _{OUT} 29	
34	HV _{OUT} 28	
35	HV _{OUT} 27	
36	HV _{OUT} 26	
37	HV _{OUT} 25	
38	HV _{OUT} 24	
39	HV _{OUT} 23	
40	HV _{OUT} 22	
41	HV _{OUT} 21	
42	HV _{OUT} 20	
43	HV _{OUT} 19	
44	HV _{OUT} 18	

44-Lead PLCC Package Outline (PJ)

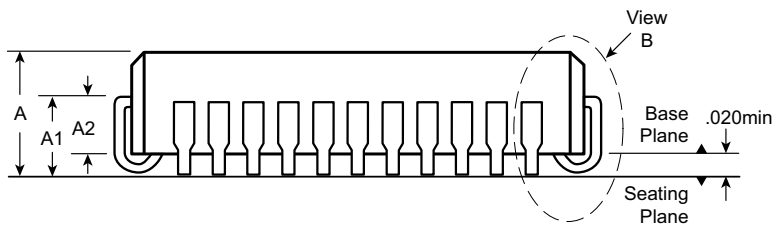
.653x.653in body, .180in height (max), .050in pitch



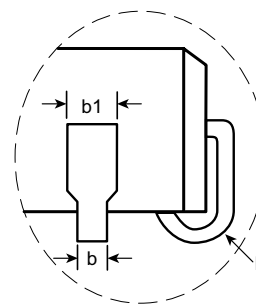
Top View



Vertical Side View



Horizontal Side View



View B

Notes:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
2. Actual shape of this feature may vary.

Symbol		A	A1	A2	b	b1	D	D1	E	E1	e	R
Dimension (inches)	MIN	.165	.090	.062	.013	.026	.685	.650	.685	.650	.050 BSC	.025
	NOM	.172	.105	-	-	-	.690	.653	.690	.653		.035
	MAX	.180	.120	.083	.021	.036†	.695	.656	.695	.656		.045

JEDEC Registration MS-018, Variation AC, Issue A, June, 1993.

† This dimension differs from the JEDEC drawing.

Drawings not to scale.

Supertex Doc. #: DSPD-44PLCCPJ, Version F031111.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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